

HPL resistivity *measurement* in Pavia

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With:

- A "Portable" instrument: <u>wet measurements</u> on 30 cm x 30 cm (max) samples
- A "Fixed " instrument: <u>dry measurements</u> on an entire panel (9 measurements in 9 different positions across the panel)

1) <u>"Portable" Instrument:</u>

a) Piston regulated by an electro-valve











 $\rho = \left(\frac{HV}{V_s} - 1\right) \times f(g) \times f(H,T)$



b) We measure the voltage $V_{\rm s}$ across a resistor $\rm R_{\rm s}$ in series to the piston

A model for the measurement.



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 $V_{s} = HV - V(t) = HV - \frac{r}{r_{t}r_{s}}HV \left(1 - e^{-e^{t}}\right) = \frac{r_{s}}{r_{t}r_{s}}HV + \frac{r}{r_{t}r_{s}}HV = e^{-e^{t}}$ We wait untill the voltage becomes steady and we <u>use</u> that value (after a while the voltage rises again due to the adjacent cells that start to inject current into the system or to discharge the capacitor – we do not use guard ring here) US HU http://www.pv.infn.it/~vitulo/DSCN1707.MOV $\frac{C_{S}}{T+P_{S}} HV = V_{S} \frac{R_{S}Q}{RQ+R_{S}Q} HV = V_{S}$ $\frac{HV}{V_{\rm S}} = R_{\pm} \Omega_{\rm S}$ HV 1 K =W C I $V_s = I R_s$ $\frac{J = M_{1}}{R + R_{1}} = \frac{V_{1}}{R + R_{2}} = \frac{H_{1}}{R + R_{2}} = \frac{H_{2}}{R + R_{2}}$ $RV_{s} + R_{s}V_{s} = HVR_{s} \Rightarrow RV_{s} = (HV - V_{s})R_{s} \Rightarrow R = HV - K_{s}R_{s}$ $R = \left(\frac{HU}{V} - 1 \right) \cdot R_{S}$

1) <u>"Fixed" Instrument:</u>

Automatic Resistivity System.

- a) 9 points of measure on the panel
- b) Electrodes made by conductive rubber (dry measurement)





Calibration:

Typically the resistivity is measured using a water soaked pad mounted on a piston. Our system uses a dry pad with safety ring and therefore a calibration is required to scale the values obtained to those of a water pad.

The calibration is performed on a small sample of HPL, whose resistivity is measured both with wet and with dry pad.

The ratio

$$A = \frac{\langle V_{H_20} \rangle}{\langle V_i \rangle} \times 1.17$$

is then calculated and used in the automated software to correct the results. The factor 1.17 accounts for the different geometry of the two pads.

1) Measure of $\langle V_{H20} \rangle$

Using the wet piston system, the voltage drop across the HPL is measured several times and the average is calculated.

2) Measure of $\langle V_i \rangle$

A LABView software allows to measure the voltage drop on each of the nine dry pistons V_i. The measure has to be performed using the same HPL sample used for the wet system under piston *i*, and using other eight spare HPL plates for the other pistons. After one measurement the sample is moved to another piston until all of them are measured. The average $\langle Vi \rangle$ is used to calculate **A**. Furthermore the ratio $\sigma[V_i]/\langle V_i \rangle$ provides an idea of the error in the measurement of a full plate: tipically such ratio is comprised between 10% and 15%.

Temperature

For our purposes the range of values is $1-6x10^{10} \Omega$ cm. Resistivity is usually done at T=20 °C, so if a measure has to be performed at T_{amb}, a formula can be used to correct it:

$$\frac{\rho_{20}}{\rho_{T_{amb}}} = e^{\alpha(T_{amb}-20)}$$

Where α is a function of the percentual humidity H%.

The software automatically measures and saves T_{amb} , however it is recommended to measure the temperature on the plate, since typically the HPL has a higher termical capacitance.

The difference between ambience and plate can be inserted in the formula through the **DTc** value. $DTc = T_{amb} - T_{plate}$

The value of α can be obtained from a table